Unit: mm

TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π-MOSIII)

# 2SK2718

### DC-DC Converter and Motor Drive Applications

 $\begin{array}{ll} \bullet & \text{Low drain-source ON resistance} & : R_{DS \; (ON)} = 5.6 \; \Omega \; (typ.) \\ \bullet & \text{High forward transfer admittance} & : |Y_{fs}| = 2.0 \; S \; (typ.) \\ \bullet & \text{Low leakage current} & : I_{DSS} = 100 \; \mu A \; (max) \; (V_{DS} = 720 \; V) \\ \bullet & \text{Enhancement mode} & : V_{th} = 2.0 \sim 4.0 \; V \; (V_{DS} = 10 \; V, I_{D} = 1 \; mA) \\ \end{array}$ 

### Maximum Ratings (Ta = 25°C)

Characteris	stics	Symbol	Rating	Unit
Drain-source voltage		$V_{DSS}$	900	V
Drain-gate voltage (R <sub>GS</sub> = 20 kΩ)		$V_{DGR}$	900	V
Gate-source voltage		V <sub>GSS</sub>	±30	V
Drain current	DC (Note 1)	I <sub>D</sub>	2.5	А
	Pulse (Note 1)	$I_{DP}$	7.5	Α
Drain power dissipation	n (Tc = 25°C)	P <sub>D</sub>	40	W
Single pulse avalanche energy (Note 2)		E <sub>AS</sub>	216	mJ
Avalanche current		I <sub>AR</sub>	2.5	Α
Repetitive avalanche energy (Note 3)		E <sub>AR</sub>	4.0	mJ
Channel temperature		T <sub>ch</sub>	150	°C
Storage temperature range		T <sub>stg</sub>	-55~150	°C

# 1. GATE 2. DRAIN 3. SOURCE JEDEC JEITA SC-67 TOSHIBA 2.7±0.2

Weight: 1.9 g (typ.)

### **Thermal Characteristics**

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R <sub>th (ch-c)</sub>	3.125	°C/W
Thermal resistance, channel to ambient	R <sub>th (ch-a)</sub>	62.5	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2:  $V_{DD}$  = 90 V,  $T_{ch}$  = 25°C (initial), L = 63.4 mH,  $R_{G}$  = 25  $\Omega$ ,  $I_{AR}$  = 2.5 A

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device.

Please handle with caution.



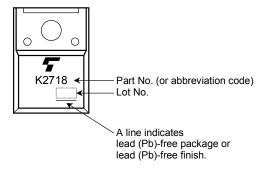
# **Electrical Characteristics (Ta = 25°C)**

Charac	eteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	rrent	I <sub>GSS</sub>	V <sub>GS</sub> = ±25 V, V <sub>DS</sub> = 0 V	_	_	±10	μΑ
Gate-source bre	eakdown voltage	V (BR) GSS	I <sub>G</sub> = ±10 μA, V <sub>DS</sub> = 0 V	±30	_	_	V
Drain cut-off cu	rrent	I <sub>DSS</sub>	V <sub>DS</sub> = 720 V, V <sub>GS</sub> = 0 V	_	_	100	μA
Drain-source br	eakdown voltage	V (BR) DSS	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0 V	900	_	_	V
Gate threshold v	oltage	V <sub>th</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	2.0	_	4.0	V
Drain-source O	N resistance	R <sub>DS (ON)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 1.5 A	_	5.6	6.4	Ω
Forward transfer	admittance	Y <sub>fs</sub>	V <sub>DS</sub> = 20 V, I <sub>D</sub> = 1.5 A	1.0	2.0	_	S
Input capacitano	e	C <sub>iss</sub>		_	510	_	
Reverse transfer	verse transfer capacitance $C_{rss}$ $V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, f = 1 MHz	_	10	_	pF
Output capacitance		C <sub>oss</sub>		_	55	_	
Switching time	Rise time	t <sub>r</sub>	$V_{GS} = 1.5A$ $V_{OUT}$ $V_{GS} = 1.5A$ $V_{OUT}$ $V_{DD} = 400V$	_	20	_	
	Turn-on time	t <sub>on</sub>		_	60	_	nc
	Fall time	t <sub>f</sub>		_	40	_	ns
	Turn-off time	t <sub>off</sub>	Duty $\leq 1\%$ , $t_{\rm W} = 10 \mu \rm s$	_	115		
Total gate charge (gate-source plus gate-drain)		Qg			21		
Gate-source charge		$Q_{gs}$	$V_{DD} \approx 400 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 2.5 \text{ A}$		11		nC
Gate-drain ("miller") Charge		Q <sub>gd</sub>			10	_	

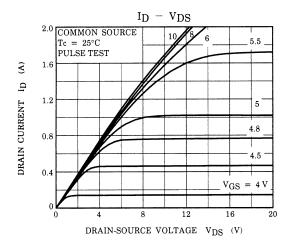
# Source-Drain Ratings and Characteristics (Ta = 25°C)

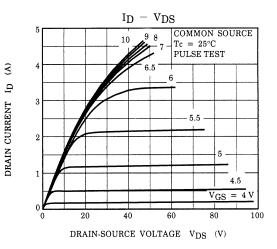
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I <sub>DR</sub>	_	_	_	2.5	Α
Pulse drain reverse current (Note 1)	I <sub>DRP</sub>	_	_	_	7.5	Α
Forward voltage (diode)	V <sub>DSF</sub>	I <sub>DR</sub> = 2.5 A, V <sub>GS</sub> = 0 V	_	_	-2.0	V
Reverse recovery time	t <sub>rr</sub>	I <sub>DR</sub> = 2.5 A, V <sub>GS</sub> = 0 V	_	960	_	ns
Reverse recovery charge	Qrr	dI <sub>DR</sub> / dt = 100 A / μs	_	5.3	_	μC

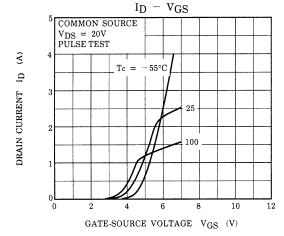
## Marking

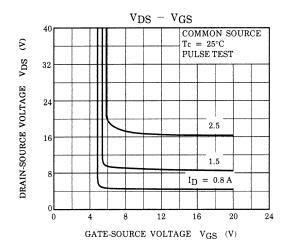


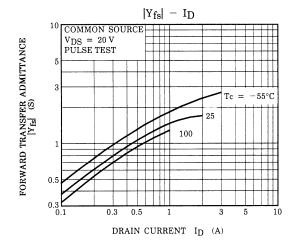
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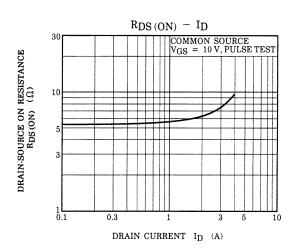


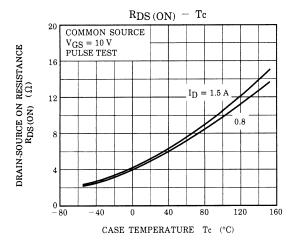


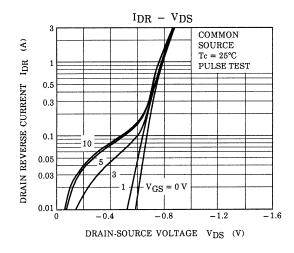


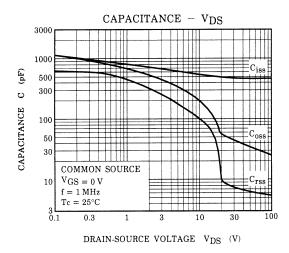


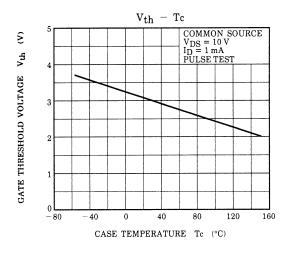


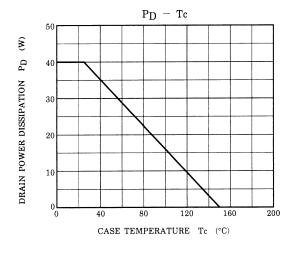


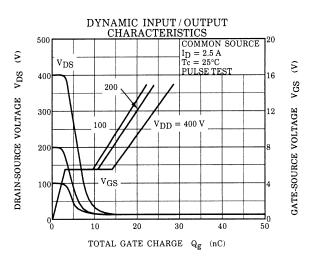




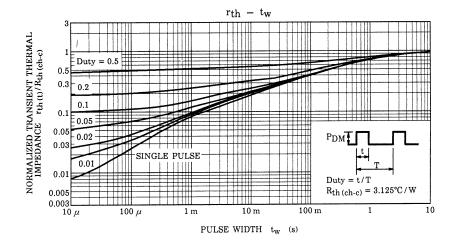


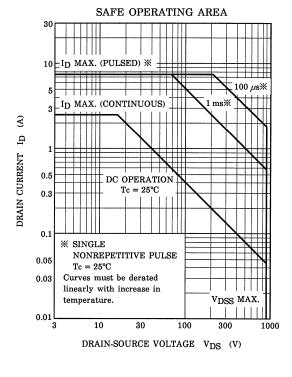


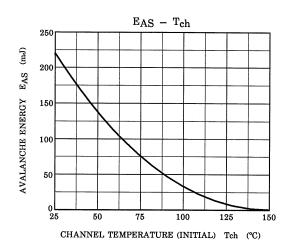


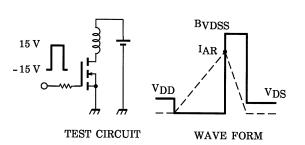


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$$\begin{aligned} &RG = 25~\Omega \\ &V_{DD} = 90~V,~L = 63.4~mH \end{aligned} \qquad EAS = \frac{1}{2} \cdot L \cdot I^2 \cdot \left( \frac{BVDSS}{BVDSS - VDD} \right)$$

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